Masterclass | The State of the Art in Electronics COMPANY OVERVIEW AND T&M, KEY AREAS OF INNOVATION

Prof. Dr. Ulrich L. Rohde

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MASTERCLASS

NOVEMBER CHAPTER

THE STATE OF ART IN ELECTRONICS BY Dr. ULRICH L. ROHDE

PROFESSOR | AUTHOR | ENTREPRENEUR | ENGINEER

Join us for an insightful session on the State of Art in Electronics where innovation meets precision in the world of electronic design.

DETAILS OF THE SESSION

State of art in Electronics - higher density, lower power, SoCs

State of art in Communications - 5/6 G and LEO satellite communication

State of art in Testing & Measurement R&S story

Systems engineering is critical for complex systems and role of software defined systems

Why and how you can be innovative?

The need and the process to be current in Technology - active participation in professional societies

TATA ADV

Date : 18th November 2024 Time : 4 to 5:15PM

Teams invite will be shared separately



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- Professor of Microwave Technology at IIT-Delhi
- Professor of Microwave and RF at the BTU Cottbus-Senftenberg University of Technology, Germany
- Full professor of Radio & Microwave Theory & Techniques at the University of Oradea, Romania
- Professor at the German Armed Forces University Munich, Germany (Microwave Systems, Technical computer science)
- Honorary professor at several other universities
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- Partner of Rohde & Schwarz, Germany
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Masterclass | The State of the Art in Electronics STATE OF THE ART IN ELECTRONICS HIGHER DENSITY, LOWER POWER, AND SOCS

KEY POINTS TO PONDER

Where do we come from?

Where are we today?

Where do we want to go?

An important principle: There are no free lunches!

Historical background:

- 1906: Lee de Forest invented the 'Audion' triode vacuum tube
- Enabled development of electronic oscillators and amplifiers
- Advantages of tubes: Thermal radiation, lax current limits, and robust power handling
- 1958: Jack Kilby (Texas Instruments) invented the Integrated Circuit (IC)

Evolution:

- Early systems used discrete components allowing circuit design flexibility
- 1958: Integrated Circuits (ICs) revolutionized electronics
- Modern ICs use nanometer-scale components with low voltages and ultra-low currents
- Today: Focus on System-on-Chip (SoC) for integrated digital and analog functions

State of the art technologies

Key metrics and performance

Future directions & challenges

- Gallium Nitride (GaN): High power density, overcoming frequency limitations
- Indium Phosphide (InP): Exceptional performance, sub-THz frequencies (>1 THz)
- Silicon Germanium (SiGe): High fT (up to 700 GHz), ideal for optical and RF modules

- GaN HEMT: Low noise figure (1 dB at 1 GHz), increasing to ~5 dB at 150 GHz
- ScALN/GaN HFETs: Up to 24% Power-Added Efficiency (PAE)
- InP HBTs: Operating at frequencies up to 340 GHz, fmax > 1 THz
- SiGe BiCMOS: fT up to 700 GHz, essential for highspeed communications

- Higher integration limits flexibility; relying on building blocks
- Foundry limitations and export controls impact new designs
- Cost-performance balance remains critical in advanced electronics
- Focus on scalable, energyefficient designs for 5G/6G applications





Masterclass | The State of the Art in Electronics
COMPANY OVERVIEW AND T&M

ROHDE & SCHWARZ WHO WE ARE...





FROM A TWO-MAN LAB TO A PRIVATELY OWNED GLOBAL COMPANY



EUR 2.93 billion revenue in FY 23/24

> 14,400 employees

15% to 20% of revenue invested in R&D



WE LIVE INNOVATION AND MASTER **OUR WHOLE VALUE CHAIN**





employees in R&D



Investments in leading-edge technologies from development to production





New center for cutting-edge technology





ONE COMPANY – THREE DIVISIONS

TEST & MEASUREMENT

Wireless I Industry, Components & Research I Aerospace & Defense Testing I Automotive

TECHNOLOGY SYSTEMS

Secure Communications I SIGINT/Electronic Warfare | Monitoring & Analytics | Infrastructure & Networks I IP Network Analytics





Endpoint & Mobile Security | Secure Networks | Certified & High Grade Crypto Solutions



RELIABILITY FOR OUR CUSTOMERS, INDEPENDENCE THROUGH VERTICAL INTEGRATION AND RELEVANCE FOR SUPPLIERS

- Strong flexibility to handle a wide variety of products and changing batch sizes
- Flexible and fast deliveries to customers all over the world
- Complexity management through investments in digitalization, automatization and innovative technologies (e.g. AI and robotics)
- ► Relevant for our suppliers through close corporations in diverse market segments





SUSTAINABILITY AT ROHDE & SCHWARZ

The pursuit of sustainability has always been part of our identity. We have a responsible and value based corporate culture that is committed to acting sustainably – toward our employees, customers and partners as well as society and the environment.





R&S APPROACHES SUSTAINABILITY FROM VARIOUS ANGLES





OUR FACILITIES CONTRIBUTE TO OUR SUSTAINABILITY TARGETS





Energy efficient combined heat and power plants (CHP) in our plant in Teisnach, GER



Solar panels in our plant in Memmingen, GER



Energy Software to monitor energy use in our plants





CLOSE TO THE MARKET. CLOSE TO CUSTOMERS.

COLOMBIA

CHILE

.

Locations in around 70 countries

CANADA

Hillsborg

Milpitas Burba

San Di

- ► More than 60 subsidiaries
- ► Worldwide development centers, sales and service offices
- ► Rohde & Schwarz develops solutions for a wide range of customers in a variety of markets



TEST & MEASUREMENT



Wireless I Industry, Components & Research I Aerospace & Defense Testing I Automotive





TEST & MEASUREMENT



Wireless I Industry, Components & Research I Aerospace & Defense Testing I Automotive







Masterclass | The State of the Art in Electronics KEY AREAS OF INNOVATION

Staying **RELEVANT** through Innovation Strong in-house expertise, partnerships and bolton technology acquisitions

Focus on today's and tomorrow's cutting-edge technologies







Demand for faster Wi-Fi with low latency



Higher defense budgets worldwide



Strong new space and NTN business



For autonomous driving more and more (radar) sensors

더가

Electrification and high-voltage solutions getting more important



WE CONNECT THE WIRELESS ECOSYSTEM! WITH OUR PEOPLE, EXPERTISE AND INNOVATIVE SOLUTIONS





5G FROM TERRESTRIAL TO SPACE 3GPP CALL IT NON TERRESTRIAL NETWORKS (NTN)







DIFFERENT IMPLEMENTATIONS OF NTN – DEVICE ASPECTS 3GPP VS. PROPRIETARY



NTN USER EQUIPMENT ESSENTIAL REQUIREMENTS AND CHALLENGES

Time Synchronization		Long delay and time variant delay: Distance, UE to satellite causes long absolute delay (~40 ms for LEO and 544 ms for GEO). Orbital movement of satellite will cause a time variant delay during the connection time. Variable RTT due to Elevation angle and LEO, SIB31 K_mac (RTT calc), K_offset, SIB32, SIB19.
Frequency Synchronization	48kHz f 2GHz 48kHz	Doppler shift: Movements of LEO satellites causes a time and elevation angle variant Doppler shift.
Signal Fading	Planer rouve	Fading profiles: Beside the legacy terrestrial fading profiles, satellite connectivity requires new fading profiles such as the combination of atmospheric and terrestrial fading as well as the emulation of weather specific effects (rain, cloud, sun storms causing electron flow).
Minimum SINR		High attenuation and low SNR: The large distance causes a high free space path loss ending in a low SNR at the UE side. Minimum SINR \geq -10 dB, minimum RSRP \geq -137 dBm.
GNSS Measurements and Satellite Ephemerals	LEO CONSCIENCE CONSCIE	GNSS emulation and provisioning of ephemeris information in the first approach, NTN targets at outdoor connections, UE is capable of GNSS and determines its terrestrial position. The UE is pre-provisioned with the orbit information (ephemeris) via SIB broadcast.
Power Saving Optimizations		Cell Acquisition , mandatory GNSS, cell search, eDRX/PSM (start time of upcoming coverage info, repetitions in low CQI, UE to predict discontinuous coverage based on the satellite assistance information, SIB32.









MOBILITY SCENARIOS



- NR-NTN connection
- Target or simultaneous dual connectivity NR-NTN connection
- Target or simultaneous dual connectivity terrestrial connection





WHAT IS THE METAVERSE? AND WHAT IS IT FOR?

An immersive, pervasive, interconnected virtual 3D world shaped by extended reality applications where many people can gather to work, shop, play, and socialize, facilitated by virtual reality (VR) and augmented reality (AR) headsets via cloud computing.



The origin of the term Metaverse is in Neal Stephenson's novel "Snow Crash"





A selection, there are many others...

METAVERSE IS ON THE AGENDA OF ALL INDUSTRY PLAYERS INDUSTRIAL METAVERSE NOW, ENTERPRISE & CONSUMER FOLLOW









G Research areas from an T&M perspective **G** introduces many new technology components



A high-level overview of all these research areas is provided in one of our <u>#THINKSIX</u> videos

6G Phases and Timeline Research, ITU and 3GPP



¹⁾ IMT-2020 systems are called 5G, The ITU has already started a new technology trend report to prepare the work on "IMT-2020 and beyond" that is likely to become 6G



TOWARDS AN AI-NATIVE AIR INTERFACE FOR 6G ENHANCING THE NEURAL RECEIVER WITH CUSTOM CONSTELLATION







Spectrum for 6G – What frequencies are we talking about? **SPECTRUM CONSIDERATIONS FOR 6G IS FR3 SPECTRUM FOR 5G-ADVANCED OR 6G OR BOTH?**







SUMMARY

- Deployment of 5G networks is in full swing, although it is still a long way to go to reach its full capabilities and deliver on its promises.
- Meanwhile, researchers in academia and industry are exploring new technology components to make 6G networks and devices more efficient, intelligent, sustainable, and secure
- These new, challenging technology components will enable the next step towards an immersive, pervasive, digital experience in a hyper-connected world





HOW COULD YOU BE INNOVATIVE?



THE NEED AND THE PROCESS TO BE CURRENT IN TECHNOLOGY

Rapid technological advancements

Competitive edge

Career growth (employers value engineers who are proactive)

Problem solving skills



ACTIVE PARTICIPATION IN PROFESSIONAL SOCIETIES



Please read: https://builtin.com/hardware/moores-law

Important references:

 IEEE microwave Magazine for the Microwave & Wireless Engineer Volume 25 - Number 10 October 2024 ISSN 1527-3342 features.

 Walker, J. Fundamentals of Physics, 8th ed., John Wiley and Sons, 2008, p. 891. ISBN 9780471758013 (Wien's displacement law).

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Thank you for your attention!



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